



Data Sheet

Customer:	
Part No:	CL-SFC3020IR-850-01(30mA)
Sample No:	
Description:	IR SMD_
Item No:	

Customer					
Check	Inspection	Approval	Date		





Features:

- . High radiant power and high radiant intensity.
- . Low forward voltage.
- . Good Reliability and Long Life
- . Soldering methods: reflow soldering
- . This product doesn't contain restriction substance, comply ROHS standard
- . Pb free

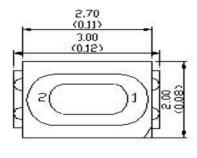
Applications

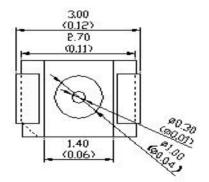
- . Remote Control.
- . Smoke detector
- . Infrared applications systems
- . Infrared remote control emission

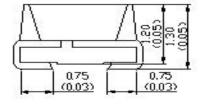
Description

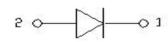
- . This infrared LED is a low power consumption diode in SMD package.
- This model has the advantages of strong transmitting power and uniform light angle.
- . The device is spectrally matched with phototransistor,
- photodiode and infrared receiver module.

Package Dimensions in millimeters

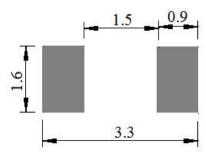








Recommended pad



Notes:

- 1 . All dimensions are in millimeters.
- 2. All dimension tolerance is ±0.2mm unless otherwise noted.
- 3. Specifications are subject to change without notice







Selection Guide

Part No.	Chip Materials	Lens Type	
CL-SFC3020IR-850-01(30mA)	AlGaAs/GaAs	Water clear	

Electrical And Optical Characteristics (Ta=25℃)

Parameter	Symbol	Min	Тур.	Max	Units	Condition
Radiant Intensity	le	2	5	1	mW/sr	IF=30mA
Forward Voltage	VF	1	1.8	1	V	IF=30mA
Reverse Current	IR	-	-	10	uA	V _R =5V
Peak Wavelength	λр	-	850	-	nm	IF=30mA
Spectral Line Half- Width	Δλ	-	50	-	nm	IF=30mA
Controlled Angle	201/2	-	120	-	deg	IF=30mA

Note:

- 1. 201/2 is the angle from optical centerline where the luminous intensity is 201/2 the optical centerline value.
- 2. the above luminous intensity measurement allowance tolerance ±10%

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Ratings	Units	Notice
Continuous Forward Current	lF	50	mA	
Power Dissipation	PD	100	mw	
Reverse Voltage	VR	5	V	
Operating Temperature	Topr	-20~+80	$^{\circ}\!$	
Storage Temperature	Tstg	-40~+100	$^{\circ}\!$	
Soldering Temperature	Ts d	260 (<10sec)	$^{\circ}$	

Typical Optical-Electrical Characteristic Curves

Fig.3 Relative Forward Voltage Vs Ambient Temperature

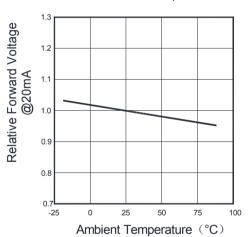


Fig.5 Spectral Distrbution

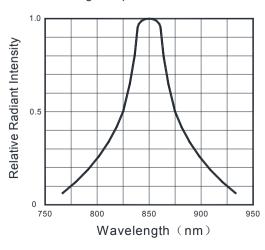


Fig.2 Relative Radiant Intensity
Vs Forward Current

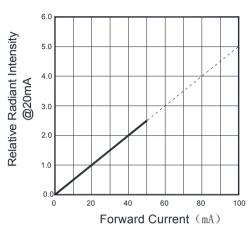


Fig.4 Relative Radiant Intensity
Vs Ambient Temperature

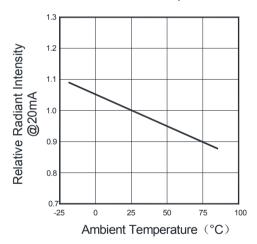
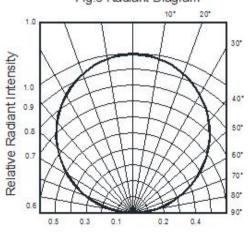


Fig.6 Radiant Diagram







Reliability Test Item And Condition

Test Item	Test Condition	Time	Quantity	Ac/Re
Life Test	Ta=25℃±5℃ IF=30mA	1000H	22	0/1
High Temperature Life Test	Ta=85℃±5℃ IF=30mA	1000H	22	0/1
Storage at High Temperature	Ta=100±5℃	1000H	22	0/1
Storage at Low Temperature	Ta=-40±5℃	1000H	22	0/1
Storage at High Temperature/High Humidity	Ta:85±5℃,RH:85±5%	1000H	22	0/1
Temperature cycle	100℃~25℃~-40℃~25℃ (30min)(5min)(30min) (5min)	100 Cycles	22	0/1
Red ink	Ta=100±5℃	2H	22	0/1
Reflow soldering	Temp:260°C max T=10 sec	3 times	22	0/1

The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license.

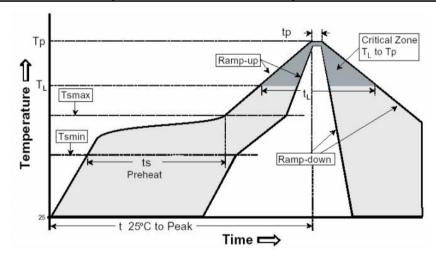




SMT Reflow Soldering Instructions

- 1. The number of reflow soldering shall not exceed two times,and the time from the second processing to the first completion shall not exceed 168H
- 2. When soldering, do not put stress on the LEDs during heating.
- 3.Reflow temperature distribution (Acc.to J-STD-020D)

	Sn-Pb Eutec	tic Assembly	Pb-Free Assembly		
Profile Feature	Large Body	Small Body	Large Body	Small Body	
Average ramp-up rate (TL to Tp)	3°C/second max.		3°C/second max.		
Preheat -Temperature Min(TSmin) -Temperature Max(TSmax) -Time(min to max)(ts)	100°C 150°C 60-120 seconds		150°C 200°C 60-180 seconds		
Tsmax to TL -Ramp-up Rate			3°C/seco	ond max.	
Time maintained above: -Temperature(TL) -Time(tL)	183℃ 60-150 seconds		217℃ 60-150 seconds		
Peak Temperature(Tp)	225+0/-5°C	240+0/-5℃	245+0/-5°C	260+0/-5°C	
Time within 5°C of actual Peak Temperature(tp)	10-30 seconds	10-30 seconds	10-30 seconds	20-40 seconds	
Ramp-down Rate	6°C/second max.		6°C/second max.		
Time 25℃ to Peak Temperatur	6 minutes max.		8 minutes max.		

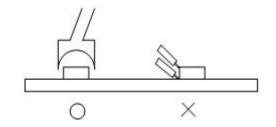


Soldering iron

- 1. When hand soldering, the temperature of the iron must less than 350 $^\circ\!\text{C}$ for 3 seconds
- 2. The hand solder should be done only one times

Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used(as below figure). It should be confirmed in advance whether the characteristics of LEDs will or will not be damaged by repairing.



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Storage

The package is sealed:

- 1.Recommended storage condition :At 5 $^{\circ}$ C $^{\sim}$ 30 $^{\circ}$ C and relative humidity 90% RH max.
- 2.It is recommended that SMD out of their original packaging are used within Half a year.

The package is opened:

- 1. Completed within 24 hours.
- 2.Stored at5°C~30°C and 60% RH or less.
- 3.LEDs stored more than 24 hours should be baked at about $65\,^{\circ}\text{C}\,\pm5\,^{\circ}\text{C}$ for at least 24 hours before solder assembly.

ESD

Static Electrisity will damage the LED.

The following procedures may decrease the possibility of ESD damage.

- 1.All productive machinery and test instruments must be electrically grounded.
- 2. Use a condustive wrist band or anti-electostatic glove when handling these LEDs.
- 3. Manintain a humidity level of 50%RHor higher in production areas.
- 4. Use anti-static packaging for transport and storage.

Handling Precautions

- 1.Do not stack together assembled PCBs containing LEDs. Impact may scratch the silicone lens or damage.
- 2.Not available in the situation of acidity for PH.
- 3. Electrostatic sensitive device



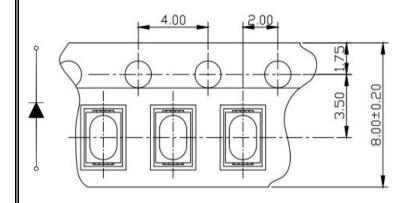


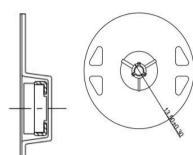


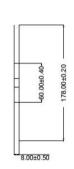




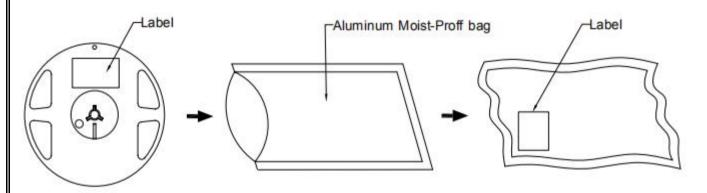
Carrier tape (MPQ:3000PCS/ree1)





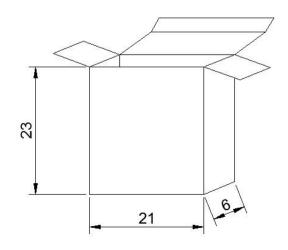


Moisture Resistant Packaging

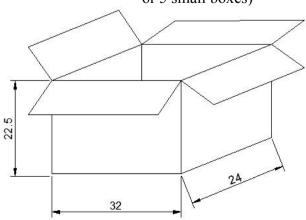


Cardboard Box

Maximum packing quantity (5 packs of material)



Maximum packing quantity (27 bags of material or 5 small boxes)



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